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(12) **United States Design Patent**  
**Finn et al.**

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- (54) **LAYOUT FOR CONTACT PADS AND CONNECTION BRIDGES OF A TRANSPONDER CHIP MODULE**
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- (52) **U.S. Cl.**  
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CPC .. G11B 7/24; G11B 7/24035; G11B 7/24038; G11B 7/24041; G11B 7/24047; G11B 7/241; G11B 7/242; G11B 7/26; G11B 7/007; G11B 7/00736; G11B 27/3027; G11B 20/1217; G11B 2020/1218; H01L 23/00; H01L 23/02; H01L 23/04; H01L 23/12; H01L 23/13; H01L 23/14; H01L 23/147; H01L 23/28; H01L 23/29; G06K 19/07749; G06K 19/07745; G06K 19/07747; G06K 19/077; G06K 19/04; G06K 19/041; G06K 19/042; G06K 19/044; G06K 19/045; G06K 19/06; G06K 19/06009; G06K 19/06018; G06K 19/06028; G06K 19/06037; G06K 19/06046; G06K 19/067; G06K 19/0672; G06K 9/0677; G06K 19/07; G06K 17/0701; G06Q 20/34; G06Q 20/341  
See application file for complete search history.

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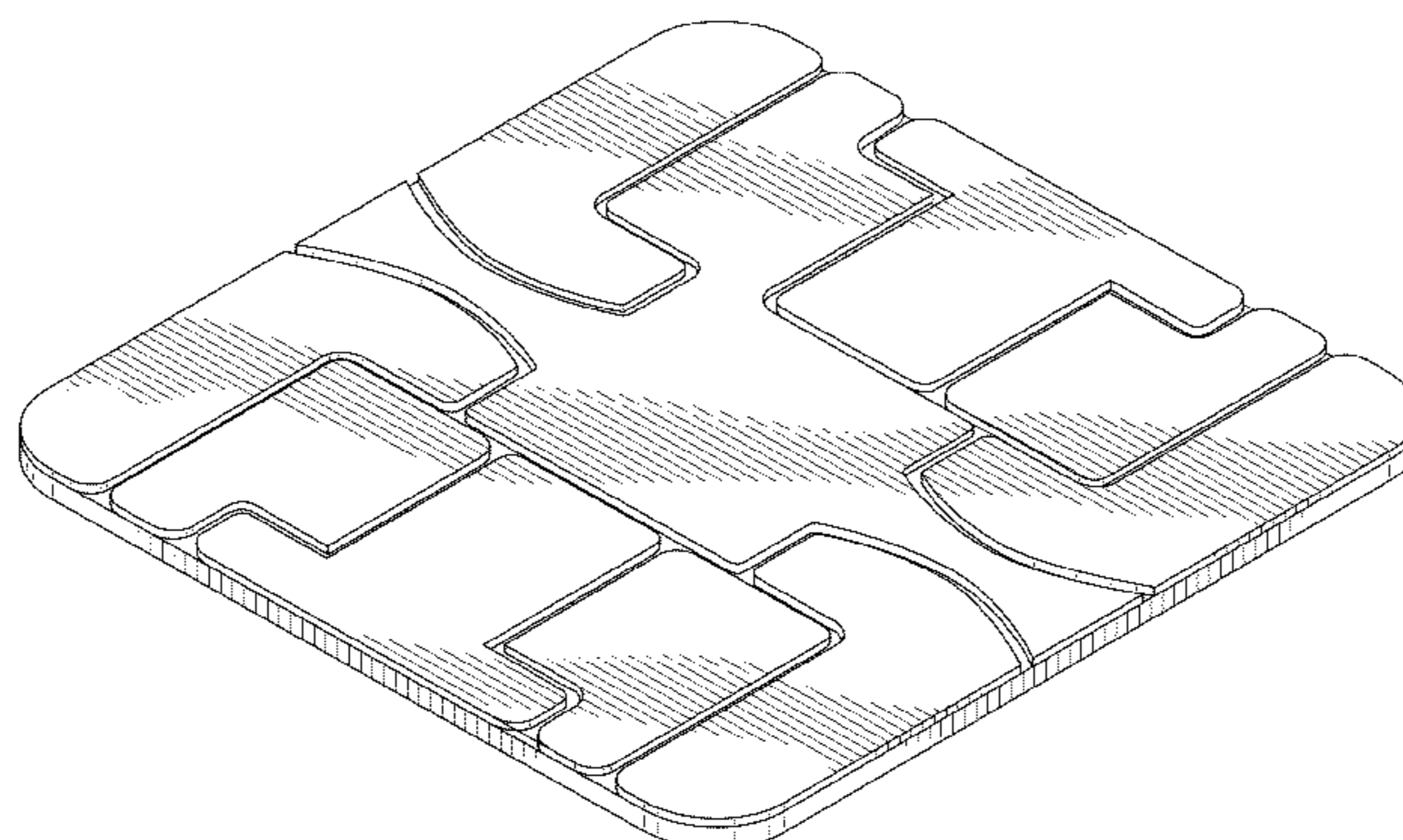
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(57) **CLAIM**  
The ornamental design for a layout for contact pads and connection bridges of a transponder chip module, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a layout for contact pads and connection bridges of a transponder chip module showing our new design;  
FIG. 2 is a front elevation view thereof;  
FIG. 3 is a top plan view thereof;  
FIG. 4 is a bottom plan view thereof;  
FIG. 5 is a left side elevation view thereof; and,  
FIG. 6 is a right side elevation view thereof.  
Portions of the article not shown form no part of the claimed design.

**1 Claim, 2 Drawing Sheets**



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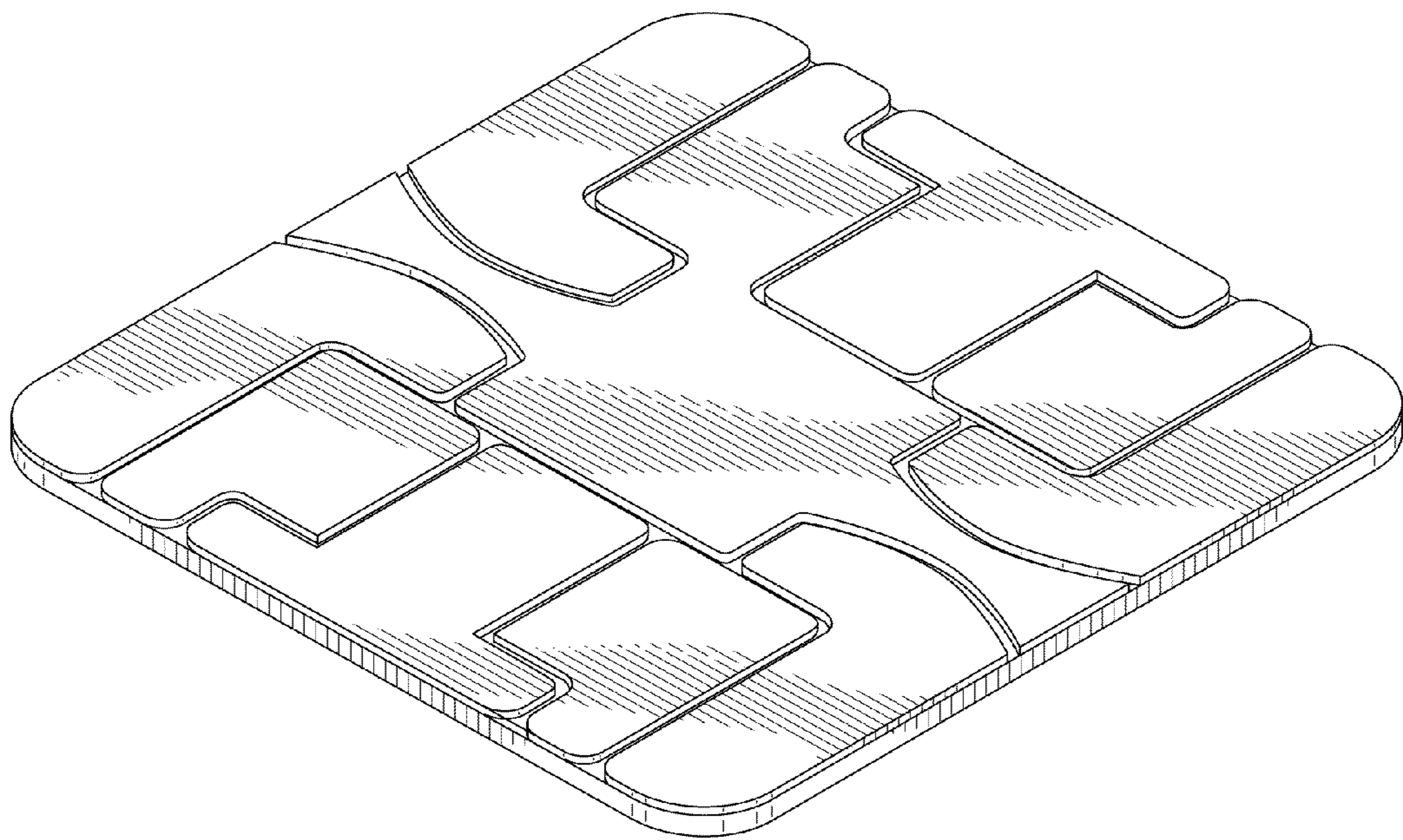
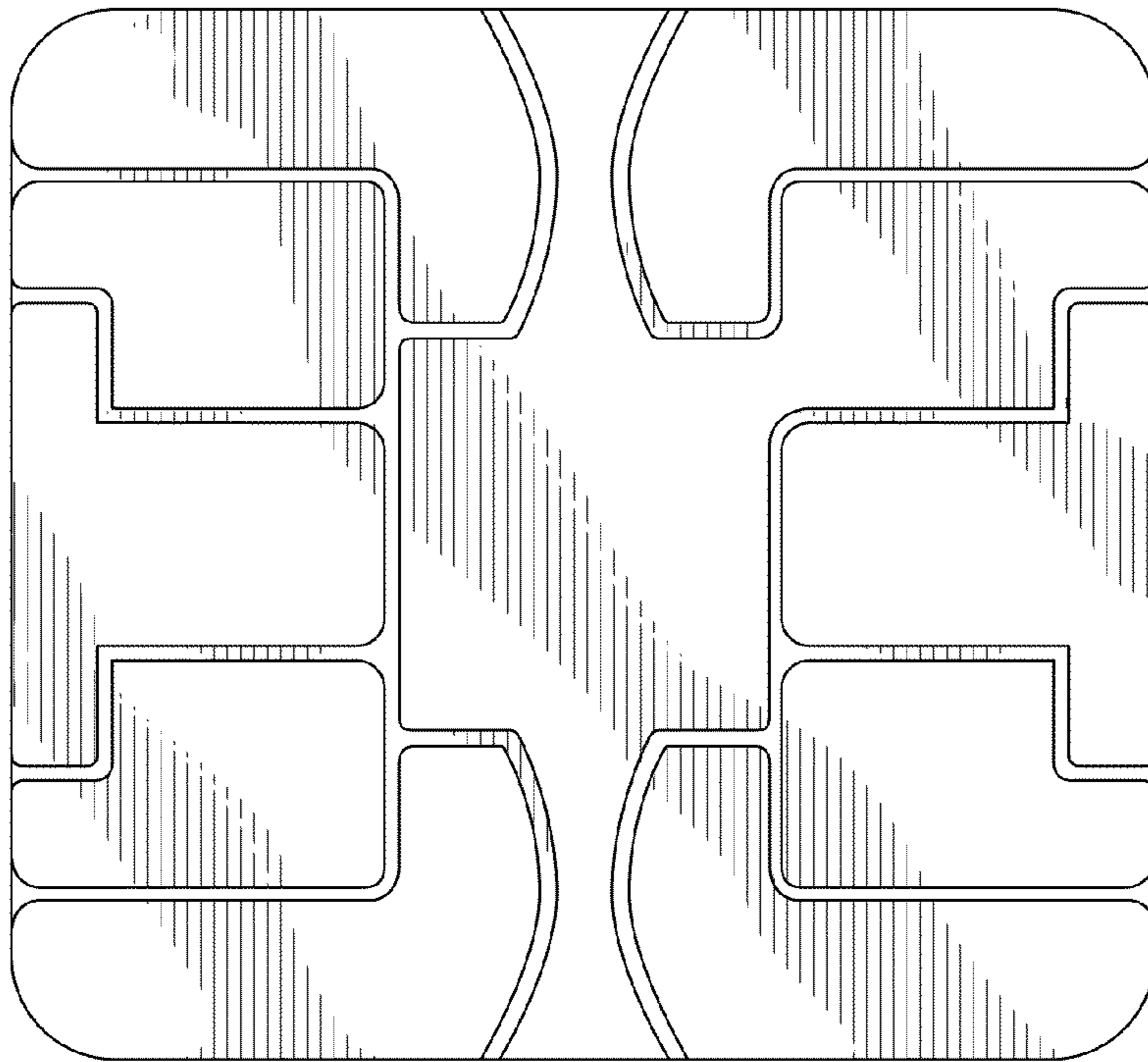
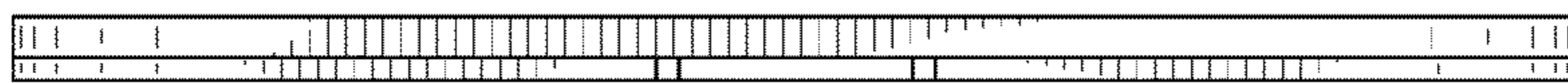


FIG. 1



*FIG. 2*



*FIG. 3*



*FIG. 4*



*FIG. 5*



*FIG. 6*